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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAT2267H

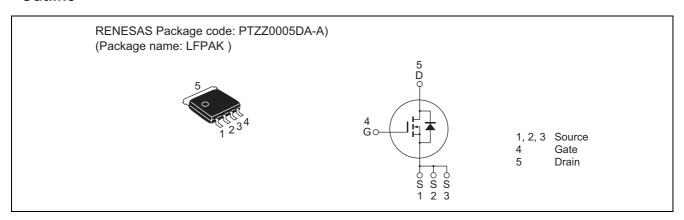
Silicon N Channel Power MOS FET Power Switch

REJ03G1463-0400 Rev.4.00 Jul 05, 2006

Features

- High speed switching
- Capable of 6 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 13 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$
- Lead Free

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	80	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	25	Α
Drain peak current	I _{D(pulse)} Note1	100	Α
Body-drain diode reverse drain current	I _{DR}	25	Α
Avalanche current	I _{AP} Note 2	15	Α
Avalanche energy	E _{AR} Note 2	30	mJ
Channel dissipation	Pch Note3	25	W
Channel to Case Thermal Resistance	θch-C	5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW ≤ 10 ∞s, duty cycle ≤ 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. $Tc = 25^{\circ}C$

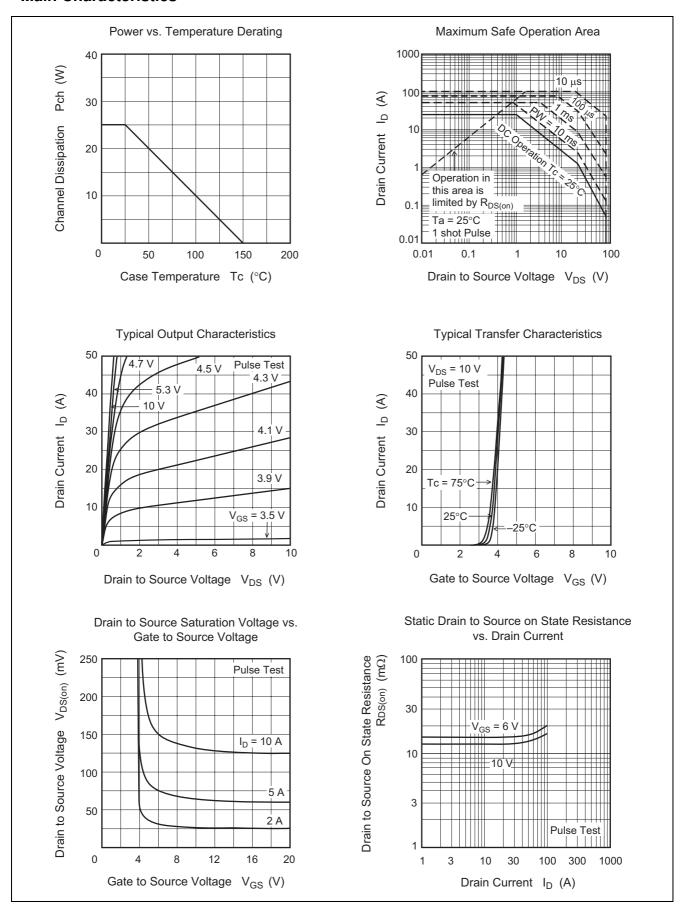
Electrical Characteristics

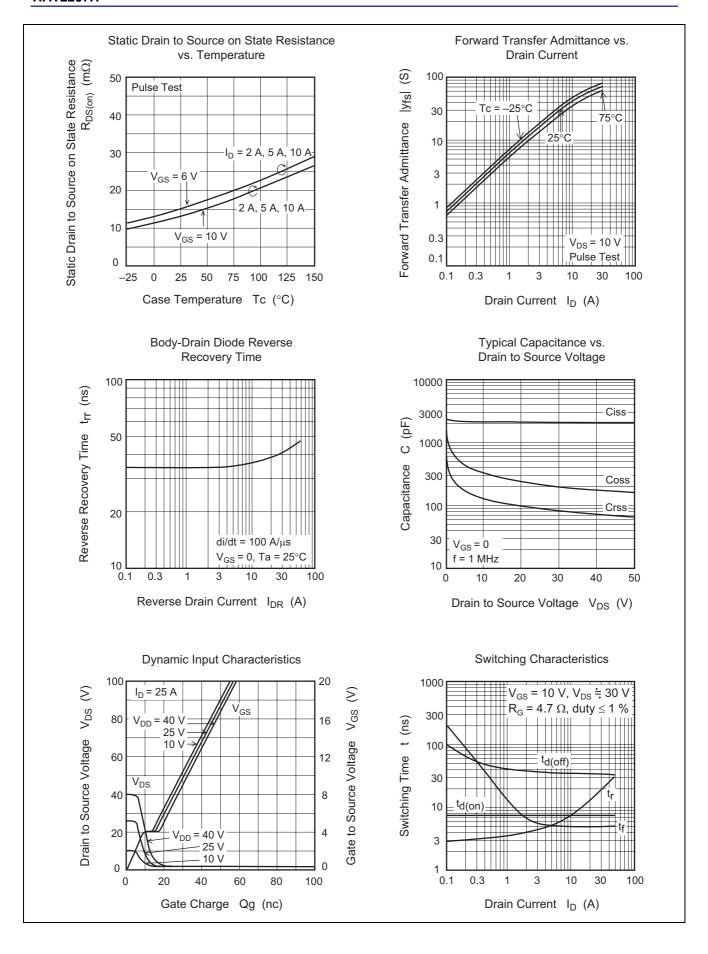
 $(Ta = 25^{\circ}C)$

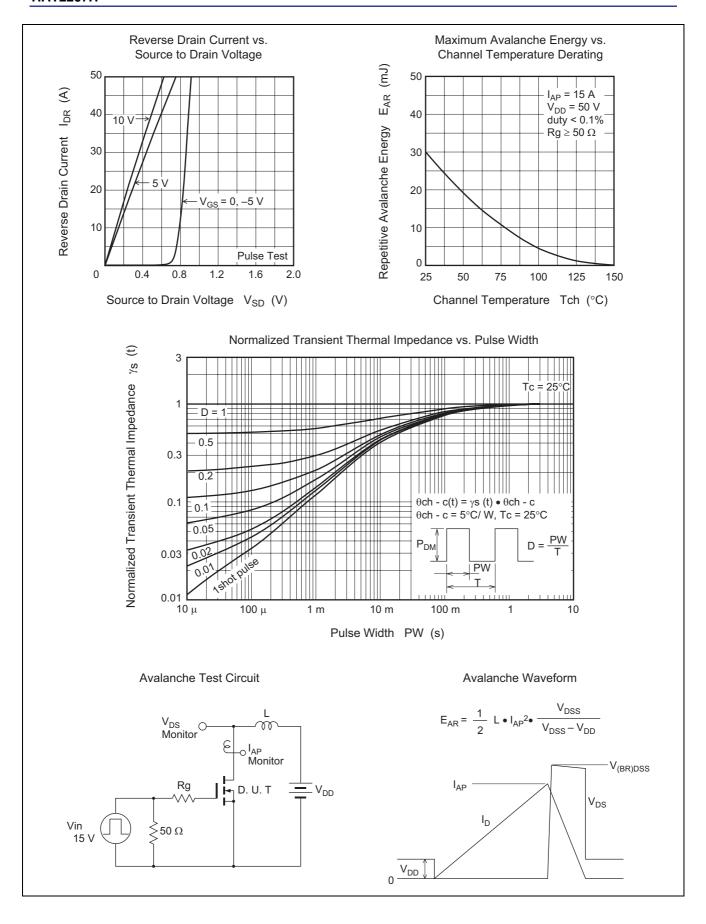
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	80	—		٧	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±0.1	∝A	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	∝A	$V_{DS} = 80 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	4.0	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	13	16	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	15	21	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 6 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	25	50		S	$I_D = 12.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	2150	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	330	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	130	_	pF	
Gate resistance	Rg	_	0.5	_	Ω	
Total gate charge	Qg	_	30	_	nC	$V_{DD} = 25 \text{ V}, V_{GS} = 10 \text{ V},$
Gate to source charge	Qgs	_	9.0	_	nC	$I_D = 25 A$
Gate to drain charge	Qgd	_	6.5	_	nC	
Turn-on delay time	t _{d(on)}	_	7.5	_	ns	$V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A},$
Rise time	t _r	_	9	_	ns	$V_{DD}\cong 30~V,~R_L=2.4~\Omega,$
Turn-off delay time	t _{d(off)}	_	35	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	5	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.83	1.08	V	$IF = 25 A$, $V_{GS} = 0$ Note4
Body-drain diode reverse recovery	t _{rr}	_	40	_	ns	$IF = 25 A, V_{GS} = 0,$
time						di _F / dt = 100 A/ ∞s

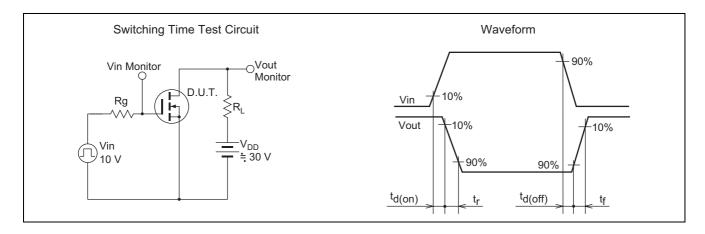
Notes: 4. Pulse test

Main Characteristics

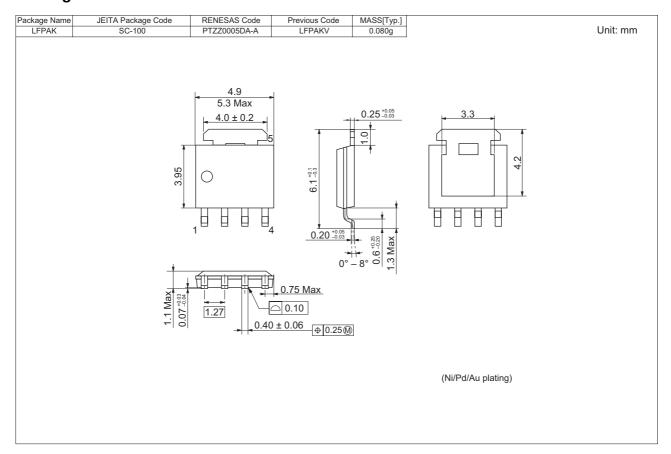








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container		
HAT2267H-EL-E	2500 pcs	Taping		

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